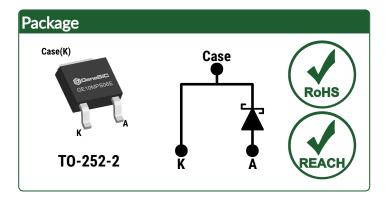
GeneSic SEMICONDUCTOR

Silicon Carbide Schottky Diode

 $V_{RRM} = 650 V$ $I_{F (Tc = 161^{\circ}C)} = 10 A$ $Q_{C} = 25 nC$

Features

- Gen5 Thin Chip Technology for Low V_F
- Low Conduction Losses for All Load Conditions
- Superior Figure of Merit Q_C/I_F
- Enhanced Surge Current Robustness
- Low Thermal Resistance
- Temperature Independent Fast Switching
- Positive Temperature Coefficient of V_F
- High dV/dt Ruggedness



Advantages

- Optimal Price Performance
- Improved System Efficiency
- Enables Extremely Fast Switching
- Reduced Cooling Requirements
- Increased System Power Density
- Zero Reverse Recovery Current
- Easy to Parallel without Thermal Runaway
- High System Reliability

Applications

- Switched Mode Power Supply (SMPS)
- Solar Inverter
- Server and Telecom Power Supply
- Battery Charger
- Uninterruptible Power Supply (UPS)
- Motor Control
- Power Factor Correction (PFC)

Absolute Maximum Ratings (At T _C = 25°C Unless Otherwise Stated)							
Parameter	Symbol	Conditions	Values	Unit	Note		
Repetitive Peak Reverse Voltage	V_{RRM}		650	٧			
		$T_C = 100^{\circ}C, D = 1$	26	5			
Continuous Forward Current	l _F	$T_C = 135^{\circ}C, D = 1$	18	Α	Fig. 4		
		$T_C = 161^{\circ}C, D = 1$	10				
Non-Repetitive Peak Forward Surge Current, Half Sine Wave	I _{F,SM}	$T_C = 25^{\circ}C$, $t_P = 10 \text{ ms}$	55	۸			
		$T_C = 150$ °C, $t_P = 10$ ms	44	Α			
Panatitiva Paak Forward Curro Current Half Cina Waya	I _{F,RM}	$T_C = 25^{\circ}C$, $t_P = 10 \text{ ms}$	33	А			
Repetitive Peak Forward Surge Current, Half Sine Wave		$T_C = 150$ °C, $t_P = 10$ ms	24				
Non-Repetitive Peak Forward Surge Current	I _{F,MAX}	T _C = 25°C, t _P = 10 μs	275	Α			
i ² t Value	∫i²dt	$T_C = 25^{\circ}C$, $t_P = 10 \text{ ms}$	15	A ² s			
Non-Repetitive Avalanche Energy	E _{AS}	L = 2.6 mH, I _{AS} = 10 A	131	mJ			
Diode Ruggedness	dV/dt	V _R = 0 ~ 520 V	200	V/ns			
Power Dissipation	Ртот	T _C = 25°C	191	W	Fig. 3		
Operating and Storage Temperature	T_j , T_{stg}		-55 to 175	°C			

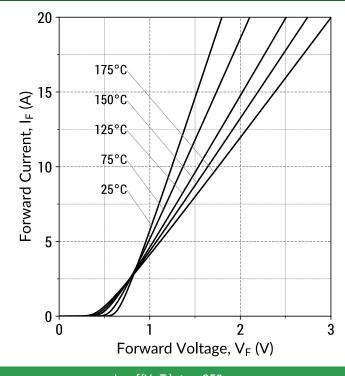


Symbol	Conditions		Values		. Unit	Note	
Зушьог			Min.	Тур.	Max.	Oilit	Note
V-	I _F = 10 A, T _j = 25°C			1.25	1.35	V	Fig. 1
VF	$I_F = 10 \text{ A}, T_j = 150^{\circ}\text{C}$			1.64			
l _a	V _R = 650 V, T _j = 25°C			1	5	μA	Fig. 2
IR	$V_R = 650 \text{ V, } T_j = 150^{\circ}\text{C}$			70			
0-	IF ≤ IF,MAX	V _R = 200 V		17		nC	Fig. 7
Q C		$V_{R} = 400 V$		25			
•	dl _F /dt = 200 A/μs	V _R = 200 V		. 10			
ιs		$V_{R} = 400 V$		< 10		115	
C	V _R = 1 V, f =	V _R = 1 V, f = 1MHz		466		nE	Fig. 6
υ 	$V_R = 400 \text{ V, f} = 1 \text{MHz}$			33		þΕ	
	Symbol V _F I _R Q _C t _S C	$V_{F} \qquad \qquad I_{F} = 10 \text{ A, } T_{j} \\ I_{F} = 10 \text{ A, } T_{j} \\ V_{R} = 650 \text{ V, } T_{j} \\ V_{R} = 1 \text{ V, } f = 0 \text{ V} \\ V_{R} = 1 \text{ V, } f = 0 \text{ V} \\ V_{R} = 1 \text{ V, } f = 0 \text{ V} \\ V_{R} = 1 \text{ V, } f = 0 \text{ V} \\ V_{R} = 1 \text{ V, } f = 0 \text{ V} \\ V_{R} = 0 \text{ V, } T_{j} \\ V_{R} = 0 \text{ V, } $	$V_{F} \qquad \begin{aligned} &I_{F} = 10 \text{ A, } T_{j} = 25^{\circ}\text{C} \\ &I_{F} = 10 \text{ A, } T_{j} = 150^{\circ}\text{C} \\ &V_{R} = 650 \text{ V, } T_{j} = 25^{\circ}\text{C} \\ &V_{R} = 650 \text{ V, } T_{j} = 150^{\circ}\text{C} \end{aligned}$ $Q_{C} \qquad \begin{aligned} &V_{R} = 650 \text{ V, } T_{j} = 150^{\circ}\text{C} \\ &V_{R} = 200 \text{ V} \\ &V_{R} = 200 \text{ V} \\ &V_{R} = 400 \text{ V} \end{aligned}$ $V_{R} = 200 \text{ V} \\ &V_{R} = 200 \text{ V} \\ &V_{R} = 200 \text{ V} \end{aligned}$ $V_{R} = 200 \text{ V} \\ &V_{R} = 200 \text{ V} \\ &V_{R} = 200 \text{ V} \end{aligned}$	$V_{F} \qquad \begin{array}{c} I_{F} = 10 \text{ A, } T_{j} = 25 ^{\circ}\text{C} \\ I_{F} = 10 \text{ A, } T_{j} = 150 ^{\circ}\text{C} \\ \\ I_{R} \qquad V_{R} = 650 \text{ V, } T_{j} = 25 ^{\circ}\text{C} \\ V_{R} = 650 \text{ V, } T_{j} = 150 ^{\circ}\text{C} \\ \\ V_{R} = 650 \text{ V, } T_{j} = 150 ^{\circ}\text{C} \\ \\ V_{R} = 200 \text{ V} \\ V_{R} = 400 \text{ V} \\ \\ \\ V_{R} = 400 \text{ V} \\ \\ \\ V_{R} = 400 \text{ V} \\ \\ V_{R} = 400 \text{ V} \\ \\ $	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$

Thermal/Package Characteristics							
Symbol	Conditions	Values			Unit	Note	
		Min.	Тур.	Max.	- Unit	Note	
R_{thJC}			0.79		°C/W	Fig. 9	
W _T			0.3		g		
	Symbol R _{thJC}	Symbol Conditions	Symbol Conditions Min.	$\begin{tabular}{c} Symbol & Conditions & \hline & Values \\ \hline Min. & Typ. \\ R_{thJC} & 0.79 \\ \hline \end{tabular}$	Symbol Conditions Values Min. Typ. Max.	$\begin{tabular}{c cccc} Symbol & Conditions & \hline & Values & & Unit \\ \hline Min. & Typ. & Max. & \\ \hline R_{thJC} & 0.79 & °C/W \\ \hline \end{tabular}$	

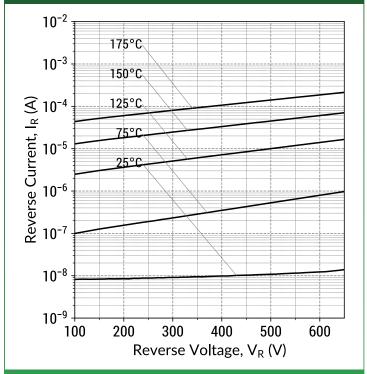






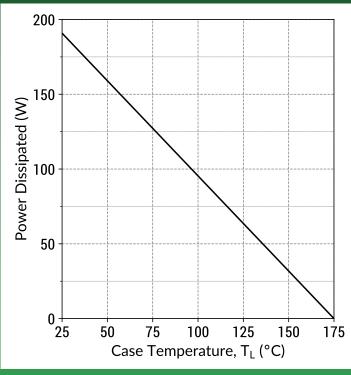
 $I_F = f(V_F, T_j); t_P = 250 \mu s$

Figure 2: Typical Reverse Characteristics



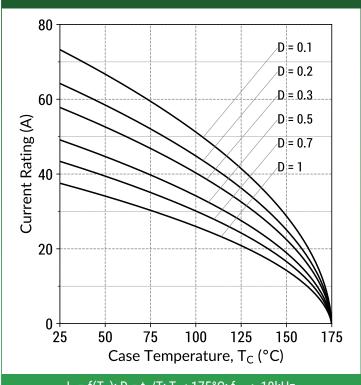
 $I_R = f(V_R, T_j)$

Figure 3: Power Derating Curves



 $P_{TOT} = f(T_C); T_j = 175^{\circ}C$

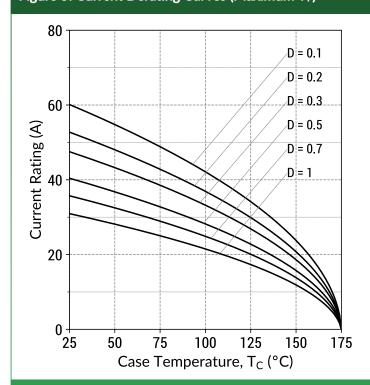
Figure 4: Current Derating Curves (Typical V_F)



 $I_F = f(T_C); D = t_P/T; T_j \le 175^{\circ}C; f_{SW} > 10kHz$

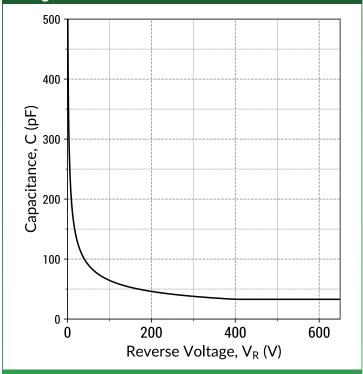


Figure 5: Current Derating Curves (Maximum V_F)



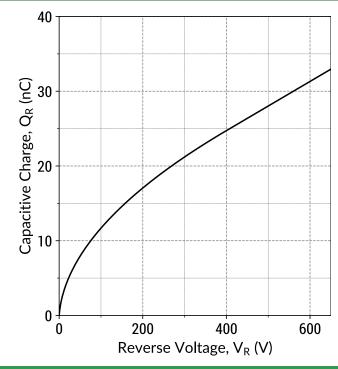
 $I_F = f(T_C); D = t_P/T; T_j \le 175^{\circ}C; f_{SW} > 10kHz$

Figure 6: Typical Junction Capacitance vs Reverse Voltage Characteristics



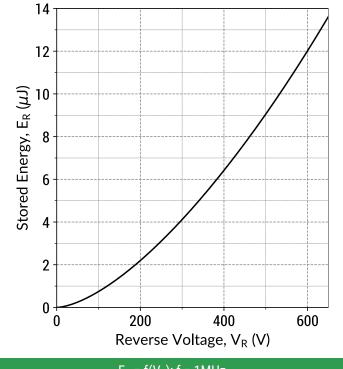
 $C = f(V_R)$; f = 1MHz

Figure 7: Typical Capacitive Charge vs Reverse Voltage Characteristics



 $Q_C = f(V_R)$; f = 1MHz

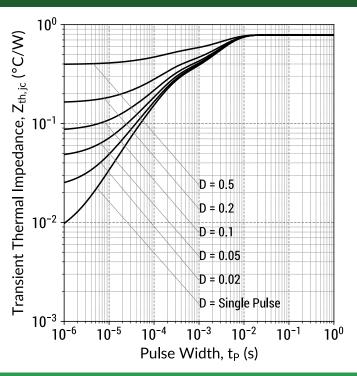
Figure 8: Typical Capacitive Energy vs Reverse Voltage Characteristics



 $E_C = f(V_R)$; f = 1MHz

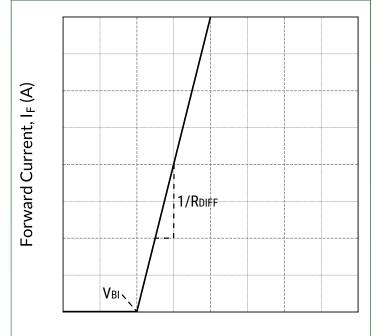


Figure 9: Transient Thermal Impedance



 $Z_{th,jc} = f(t_P,D); D = t_P/T$

Figure 10: Forward Curve Model



Forward Voltage, $V_F(V)$

 $I_F = f(V_F, T_j)$

Forward Curve Model Equation:

 $I_F = (V_F - V_{BI})/R_{DIFF}(A)$

Built-In Voltage (V_{BI}):

$$V_{BI}(T_j) = m \times T_j + n (V)$$

 $m = -0.00124 (V/^{\circ}C)$
 $n = 0.72 (V)$

Differential Resistance (RDIFF):

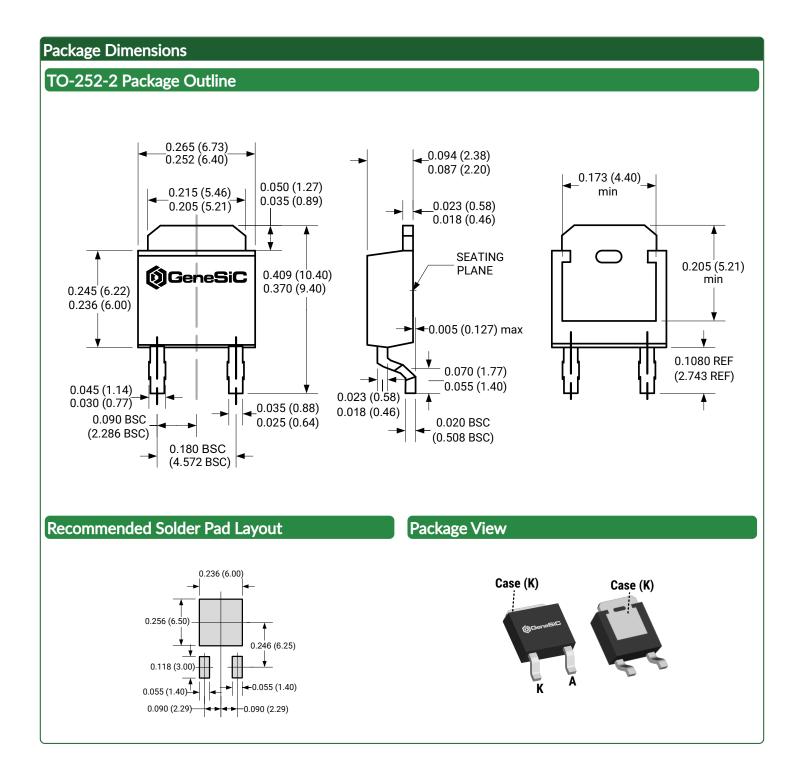
$$R_{DIFF}(T_j) = a \times T_j^2 + b \times T_j + c (\Omega)$$

 $a = 9.62e-07 (\Omega/^{\circ}C^2)$
 $b = 0.000272 (\Omega/^{\circ}C)$
 $c = 0.0481 (\Omega)$

Forward Power Loss Equation:

$$P_{LOSS} = V_{BI}(T_j) \times I_{AVG} + R_{DIFF}(T_j) \times I_{RMS}^2$$





NOTE

- 1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
- 2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS.





Compliance

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS 2), as adopted by EU member states on January 2, 2013 and amended on March 31, 2015 by EU Directive 2015/863. RoHS Declarations for this product can be obtained from your GeneSiC representative.

REACH Compliance

REACH substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a GeneSiC representative to insure you get the most up-to-date REACH SVHC Declaration. REACH banned substance information (REACH Article 67) is also available upon request.

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Related Links

SPICE Models: https://www.genesicsemi.com/sic-schottky-mps/GE10MPS06E/GE10MPS06E_SPICE.zip
 PLECS Models: https://www.genesicsemi.com/sic-schottky-mps/GE10MPS06E/GE10MPS06E_PLECS.zip
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• Evaluation Boards: https://www.genesicsemi.com/technical-support

Reliability: https://www.genesicsemi.com/reliability
 Compliance: https://www.genesicsemi.com/compliance
 Quality Manual: https://www.genesicsemi.com/quality

Revision History

Date	Revision	Comments	Supersedes
Jul. 27, 2020	Rev 1	Initial Release	



www.genesicsemi.com/sic-schottky-mps/

